

#15/Patent
4/23/3

PATENT
Customer No. 22,852
Attorney Docket No. 4329-2335



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
)
Tokuhisa OHIWA et al.) Group Art Unit: 2823
)
Serial No.: 09/604,724) Examiner: Kurt Eaton
)
Filed: June 28, 2000)
)
For: METHOD OF MANUFACTURING)
SEMICONDUCTOR DEVICE)

RECEIVED
APR 21 2003
TECHNOLOGY CENTER 2800

Assistant Commissioner for Patents
Washington, DC 20231

CLAIM FOR PRIORITY

Sir:

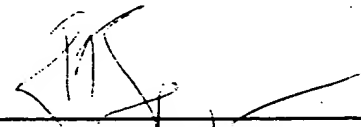
Under the provisions of Section 119 of 35 U.S.C., Applicants hereby claim the benefit of the filing date of Japan Patent Application Number 11-183908, filed June 29, 1999, for the above identified United States Patent Application.

In support of Applicants claim for priority, a certified copy of the priority application is filed herewith.

Respectfully submitted,

FINNEGAN, HENDERSON, FARABOW,
GARRETT & DUNNER, L.L.P.

Dated: May 8, 2001

By: 
Richard V. Burgujian
Reg. No. 31,744

日 本 国 特 許 庁

PATENT OFFICE
JAPANESE GOVERNMENT

別紙添付の書類に記載されている事項は下記の出願書類に記載されて
る事項と同一であることを証明する。

This is to certify that the annexed is a true copy of the following application as filed
this Office.

願 年 月 日

Date of Application:

1999年 6月29日

願 番 号

Application Number:

平成11年特許願第183908号

願

人

Applicant(s):

株式会社東芝

RECEIVED

APR 21 2003

TECHNOLOGY CENTER 2800

2000年 6月23日

特許庁長官
Commissioner,
Patent Office

近藤 隆彦

出証番号 出証特2000-3046688